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December 2010

FDD6637_F085

P-Channel PowerTrench[®] MOSFET

-35V, -21A, 18mΩ

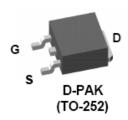
Features

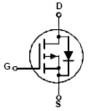
- Typ $r_{DS(on)}$ = 9.7m Ω at V_{GS} = -10V, I_D =- 14A
- Typ $r_{DS(on)}$ = 14.4m Ω at V_{GS} = -4.5V, I_D =- 11A
- Typ $Q_{g(10)}$ = 45nC at V_{GS} = -10V
- High performance trench technology for extremely low r_{DS(on)}.
- Qualified to AEC Q101
- RoHS Compliant

Applications

- Inverter
- Power Supplies







$\textbf{MOSFET Maximum Ratings} \ \, \textbf{T}_{C} = 25^{\circ}\text{C unless otherwise noted}$

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain to Source Voltage	-35	V
V _{DS(Avalanche)}	Drain to Source Avalanche Voltage (maximum)	-45	V
V_{GS}	Gate to Source Voltage	±25	V
	Drain Current Continuous (T _C < 155°C, V _{GS} = 10V)	-21	Α
'D	Pulsed	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 1)	61	mJ
D	Power Dissipation	68	W
P_{D}	Dreate above 25°C		W/oC
T _J , T _{STG}	Operating and Storage Temperature	-55 to + 175	°C

Thermal Characteristics

$R_{ heta JC}$	Maximum Thermal Resistance Junction to Case	2.2	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient TO-252, 1in ² copper pad area	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6637	FDD6637_F085	TO-252	13"	12mm	2500 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Parameter

On Cha	iracteristics					
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	-35	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -28V, V_{GS} = 0V$	-	-	-1	μА
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 25V$	-	-	±100	nA

Test Conditions

Min

Тур

Max

Units

On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-1.6	-3	V
		$I_D = -14A, V_{GS} = -10V$	-	9.7	11.6	
r _{DS(on)}	Drain to Source On Resistance	I _D = -11A, V _{GS} = -4.5V	-	14.4	18	$m\Omega$
		$I_D = -14A$, $V_{GS} = -10V$, $T_C = 150$ °C	-	15.3	18	
9 _{FS}	Forward Transconductance	V _{DS} = -5V, I _D = -14A	-	35	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	.,	$V_{DS} = -20V, V_{GS} = 0V,$ f = 1MHz		2370	-	pF
C _{oss}	Output Capacitance				470	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1101112			250	-	pF
R_G	Gate Resistance	f = 1MHz	f = 1MHz		3.6	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at -10V	V _{GS} = 0 to -10V		-	45	63	nC
$Q_{g(5)}$	Total Gate Charge at -5V	$V_{GS} = 0 \text{ to } -5V$	V _{DD} = -20V	-	25	35	nC
Q_{gs}	Gate to Source Gate Charge		I _D = -14A	-	7	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			-	10	-	nC

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	18	32	ns
t _r	Rise Time	$V_{DD} = -20V, I_D = -1A,$	1	10	20	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -10V$, $R_{GEN} = 6\Omega$	-	62	100	ns
t _f	Fall Time	GEN 011	-	36	58	ns

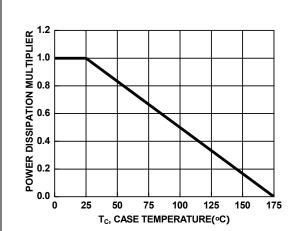
Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	I _{SD} = -14A	-	-0.8	-1.2	V
t _{rr}	Reverse Recovery Time	L = 14A dL /dt = 100A/s	-	28	37	ns
Q _{rr}	Reverse Recovery Charge	$I_F = -14A$, $dI_{SD}/dt = 100A/\mu s$	-	15	20	nC

Notes:

1: Starting $T_J = 25^{\circ}C$, L = 1mH, $I_{AS} = -11$ A, $V_{GS} = 10$ V, $V_{DD} = -35$ V during the inductor charging time and 0V during the time in avalanche

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/
All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.



Typical Characteristics

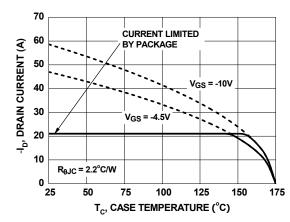
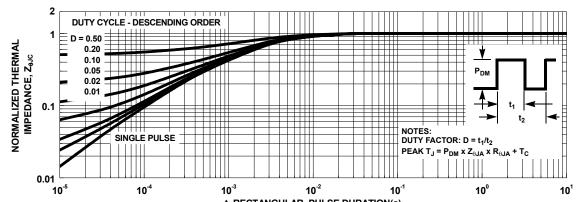


Figure 1. Normalized Power Dissipation vs Case Temperature

Figure 2. Maximum Continuous Drain Current vs Case Temperature



t, RECTANGULAR PULSE DURATION(s)
Figure 3. Normalized Maximum Transient Thermal Impedance

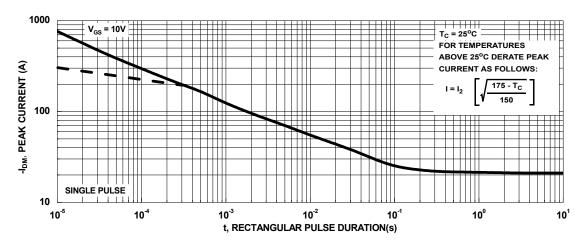


Figure 4. Peak Current Capability

Typical Characteristics

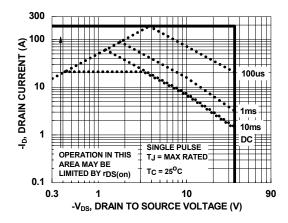
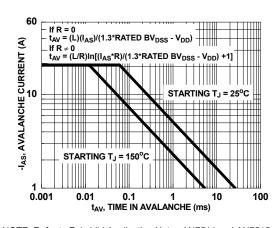


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

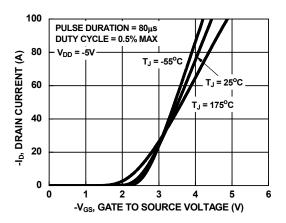


Figure 7. Transfer Characteristics

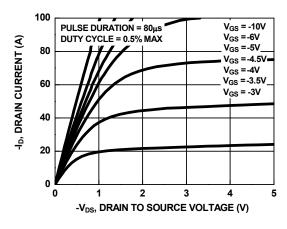


Figure 8. Saturation Characteristics

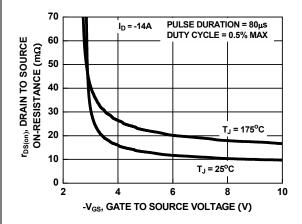


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

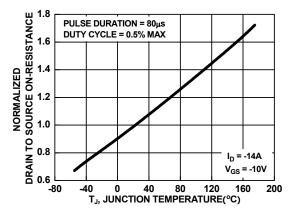


Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

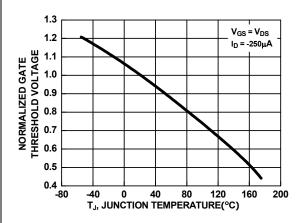


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

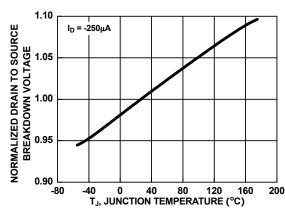


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

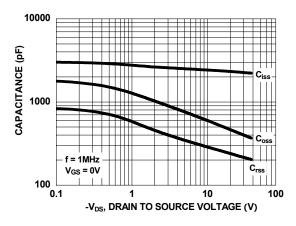


Figure 13. Capacitance vs Drain to Source Voltage

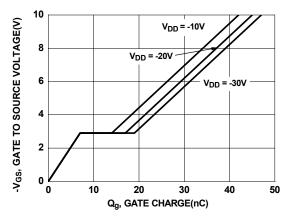


Figure 14. Gate Charge vs Gate to Source Voltage





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